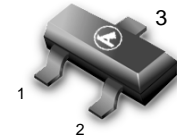
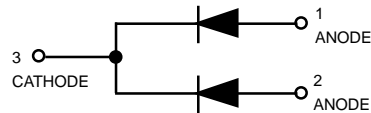


Monolithic Dual Switching Diode

BAV74LT1

 CASE 318-08, STYLE 9
 SOT-23 (TO-236AB)

DEVICE MARKING

BAV74LT1 = JA

MAXIMUM RATINGS (EACH DIODE)

Rating	Symbol	Value	Unit
Reverse Voltage	V_R	50	Vdc
Forward Current	I_F	200	mAdc
Peak Forward Surge Current	$I_{FM(surge)}$	500	mAdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board (1) $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	225	mW
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	556	$^\circ\text{C/W}$
Total Device Dissipation Alumina Substrate, (2) $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	300	mW
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	417	$^\circ\text{C/W}$
Junction and Storage Temperature	T_J, T_{stg}	-55 to +150	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted) (EACH DIODE)

Characteristic	Symbol	Min	Max	Unit
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OFF CHARACTERISTICS

Reverse Breakdown Voltage ($I_{(BR)} = 5.0 \mu\text{Adc}$)	$V_{(BR)}$	50	—	Vdc
Reverse Voltage Leakage Current ($V_R = 50 \text{ Vdc}, T_J = 125^\circ\text{C}$)	I_R	—	100	μAdc
($V_R = 50 \text{ Vdc}$)		—	0.1	
Diode Capacitance ($V_R = 0, f = 1.0 \text{ MHz}$)	C_D	—	2.0	pF
Forward Voltage ($I_F = 100 \text{ mAdc}$)	V_F	—	1.0	Vdc
Reverse Recovery Time ($I_F = I_R = 10 \text{ mAdc}, I_{R(REC)} = 1.0 \text{ mAdc}$, measured at $I_R = 1.0 \text{ mA}, R_L = 100 \Omega$)	t_{rr}	—	4.0	ns

 1. FR-5 = $1.0 \times 0.75 \times 0.062$ in.

 2. Alumina = $0.4 \times 0.3 \times 0.024$ in. 99.5% alumina.

BAV74LT1

Curves Applicable to Each Anode

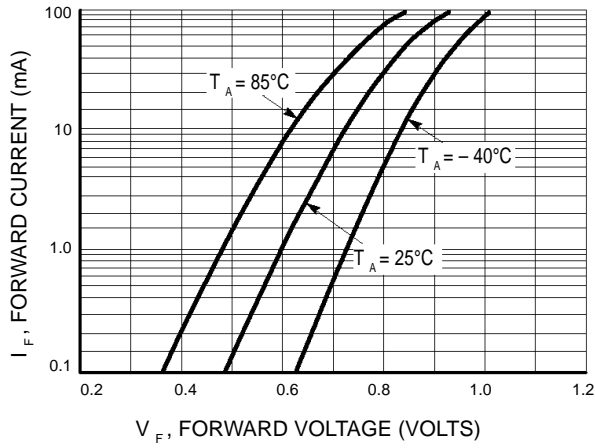


Figure 1. Forward Voltage

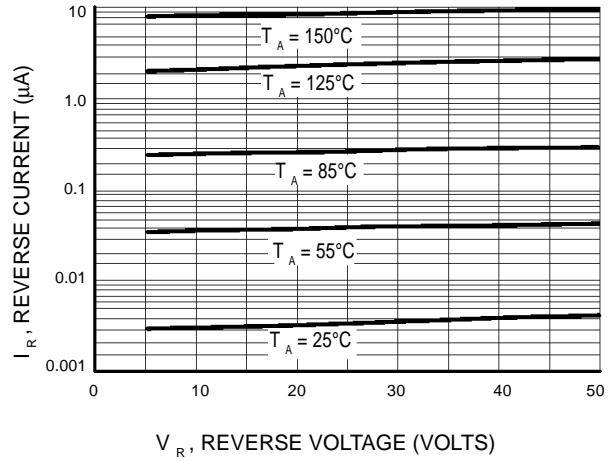


Figure 3. Leakage Current

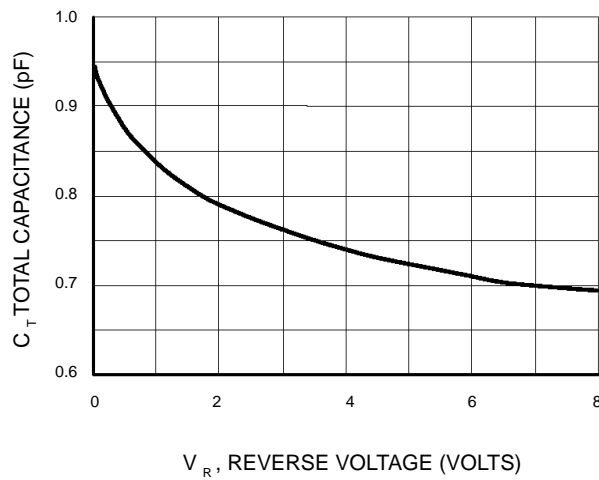


Figure 3. Capacitance